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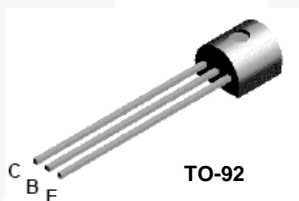
2N5551 / MMBT5551

NPN General-Purpose Amplifier

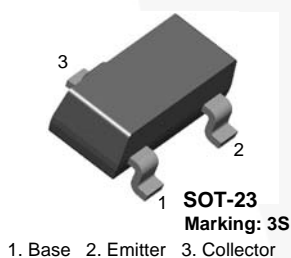
Description

This device is designed for general-purpose high-voltage amplifiers and gas discharge display drivers.

2N5551



MMBT5551



Ordering Information⁽¹⁾

| Part Number | Top Mark | Package | Packing Method |
|-------------|----------|-----------|----------------|
| 2N5551TA | 5551 | TO-92 3L | Ammo |
| 2N5551TFR | 5551 | TO-92 3L | Tape and Reel |
| 2N5551TF | 5551 | TO-92 3L | Tape and Reel |
| 2N5551BU | 5551 | TO-92 3L | Bulk |
| MMBT5551 | 3S | SOT-23 3L | Tape and Reel |

Note:

- Suffix "-C" means Center Collector in 2N5551 (1. Emitter 2. Collector 3. Base)
Suffix "-Y" means h_{FE} 180~240 in 2N5551 (Test condition: $I_C = 10$ mA, $V_{CE} = 5.0$ V)

Absolute Maximum Ratings⁽²⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Value | Units |
|----------------------|----------------------------------|-------------|------------------|
| V_{CEO} | Collector-Emitter Voltage | 160 | V |
| V_{CBO} | Collector-Base Voltage | 180 | V |
| V_{EBO} | Emitter-Base Voltage | 6 | V |
| I_C | Collector current - Continuous | 600 | mA |
| $T_J, T_{stg}^{(2)}$ | Junction and Storage Temperature | -55 to +150 | $^\circ\text{C}$ |

Notes:

- These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
- These ratings are based on a maximum junction temperature of 150°C .
These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Maximum | | Units |
|-----------------|---|---------|----------|---------------------------|
| | | 2N5551 | MMBT5551 | |
| P_D | Total Device Dissipation | 625 | 350 | mW |
| | Derate above 25°C | 5.0 | 2.8 | mW/ $^\circ\text{C}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | 357 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics⁽⁴⁾Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|-------------------------------------|--------------------------------------|---|------|------|---------------|
| Off Characteristics | | | | | |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage | $I_C = 1.0\text{ mA}, I_B = 0$ | 160 | | V |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C = 100\ \mu\text{A}, I_E = 0$ | 180 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 10\ \mu\text{A}, I_C = 0$ | 6.0 | | V |
| I_{CBO} | Collector Cut-Off Current | $V_{CB} = 120\text{ V}, I_E = 0$ | | 50 | nA |
| | | $V_{CB} = 120\text{ V}, I_E = 0, T_A = 100^\circ\text{C}$ | | 50 | μA |
| I_{EBO} | Emitter Cut-Off Current | $V_{EB} = 4.0\text{ V}, I_C = 0$ | | 50 | nA |
| On Characteristics | | | | | |
| h_{FE} | DC Current Gain | $I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$ | 80 | | |
| | | $I_C = 10\text{ mA}, V_{CE} = 5.0\text{ V}$ | 80 | 250 | |
| | | $I_C = 50\text{ mA}, V_{CE} = 5.0\text{ V}$ | 30 | | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$ | | 0.15 | V |
| | | $I_C = 50\text{ mA}, I_B = 5.0\text{ mA}$ | | 0.20 | V |
| $V_{BE(sat)}$ | Base-Emitter On Voltage | $I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$ | | 1.0 | V |
| | | $I_C = 50\text{ mA}, I_B = 5.0\text{ mA}$ | | 1.0 | V |
| Small-Signal Characteristics | | | | | |
| f_T | Current Gain Bandwidth Product | $I_C = 10\text{ mA}, V_{CE} = 10\text{ V},$ $f = 100\text{ MHz}$ | 100 | | MHz |
| C_{obo} | Output Capacitance | $V_{CB} = 10\text{ V}, I_E = 0, f = 1.0\text{ MHz}$ | | 6.0 | pF |
| C_{ibo} | Input Capacitance | $V_{BE} = 0.5\text{ V}, I_C = 0, f = 1.0\text{ MHz}$ | | 20 | pF |
| H_{fe} | Small-Signal Current Gain | $I_C = 1.0\text{ mA}, V_{CE} = 10\text{ V}, f = 1.0\text{ kHz}$ | 50 | 250 | |
| NF | Noise Figure | $I_C = 250\ \mu\text{A}, V_{CE} = 5.0\text{ V},$ $R_S = 1.0\text{ k}\Omega, f = 10\text{ Hz to }15.7\text{ kHz}$ | | 8.0 | dB |

Note:4. PCB board size FR-4 76 x 114 x 0.6 T mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Typical Performance Characteristics

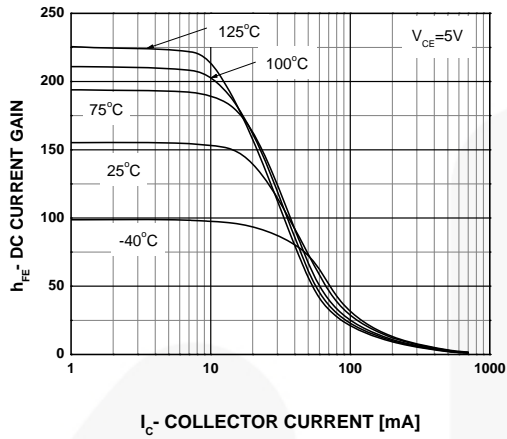


Figure 1. Typical Pulsed Current Gain vs. Collector Current

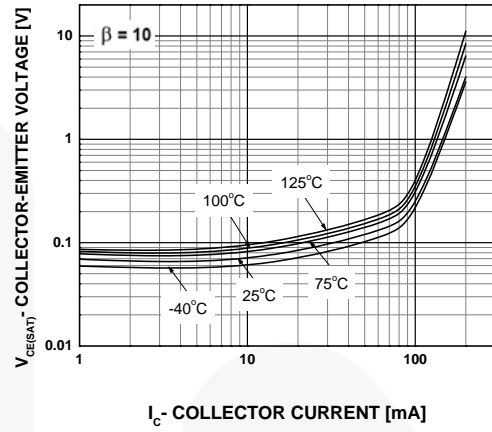


Figure 2. Collector-Emitter Saturation Voltage vs. Collector Current

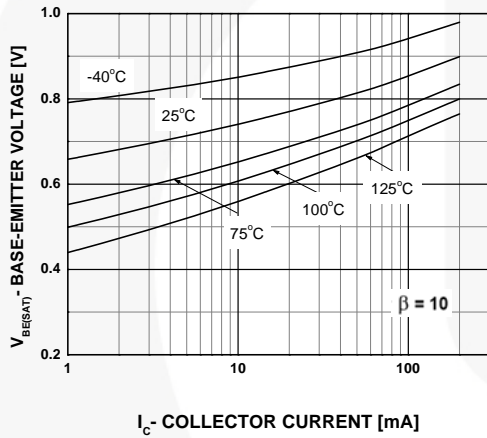


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

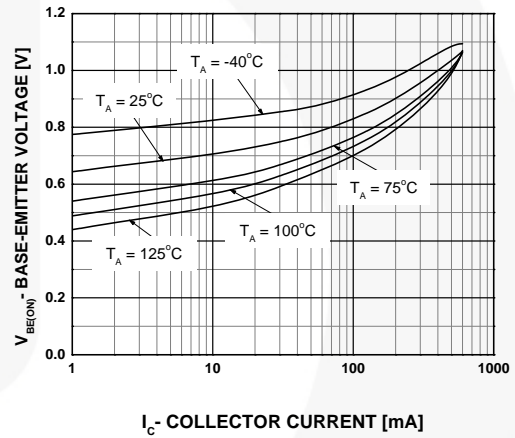


Figure 4. Base-Emitter On Voltage vs. Collector Current

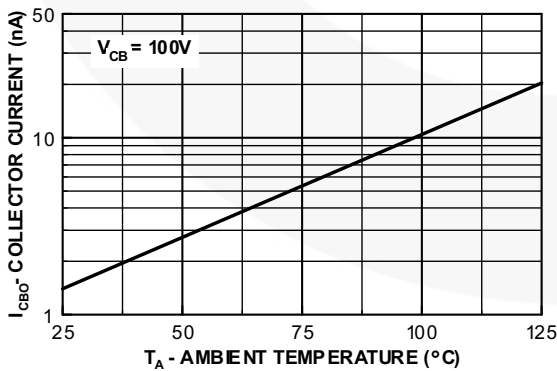


Figure 5. Collector Cut-Off Current vs. Ambient Temperature

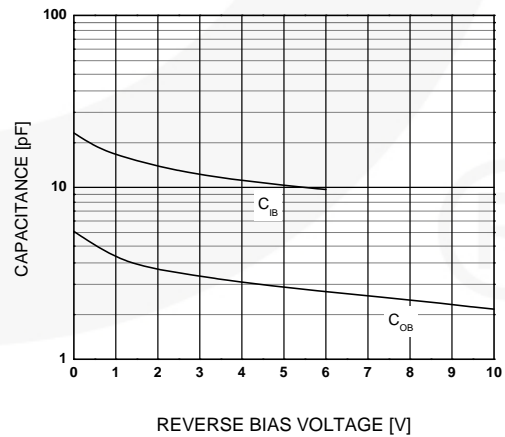


Figure 6. Input and Output Capacitance vs. Reverse Voltage

Typical Performance Characteristics (Continued)

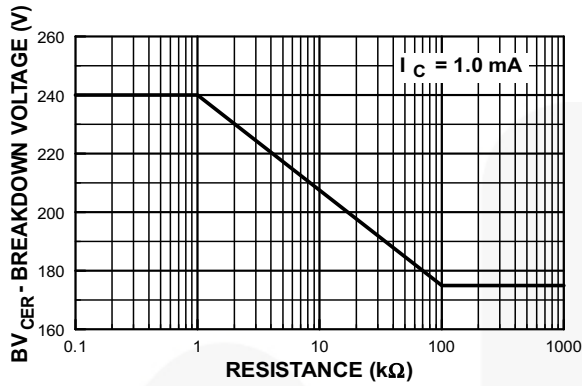


Figure 7. Collector- Emitter Breakdown Voltage with Resistance between Emitter-Base

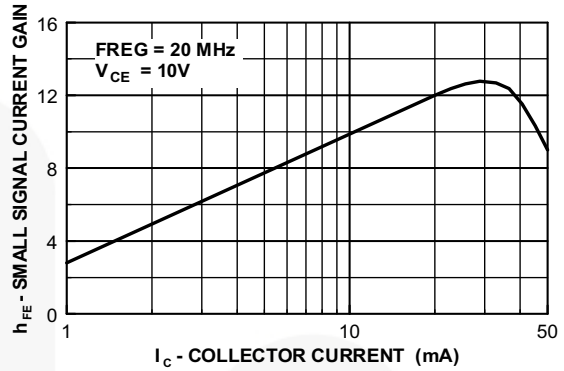


Figure 8. Small Signal Current Gain vs. Collector Current

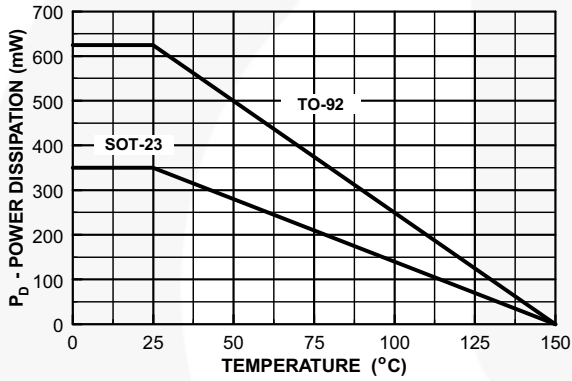
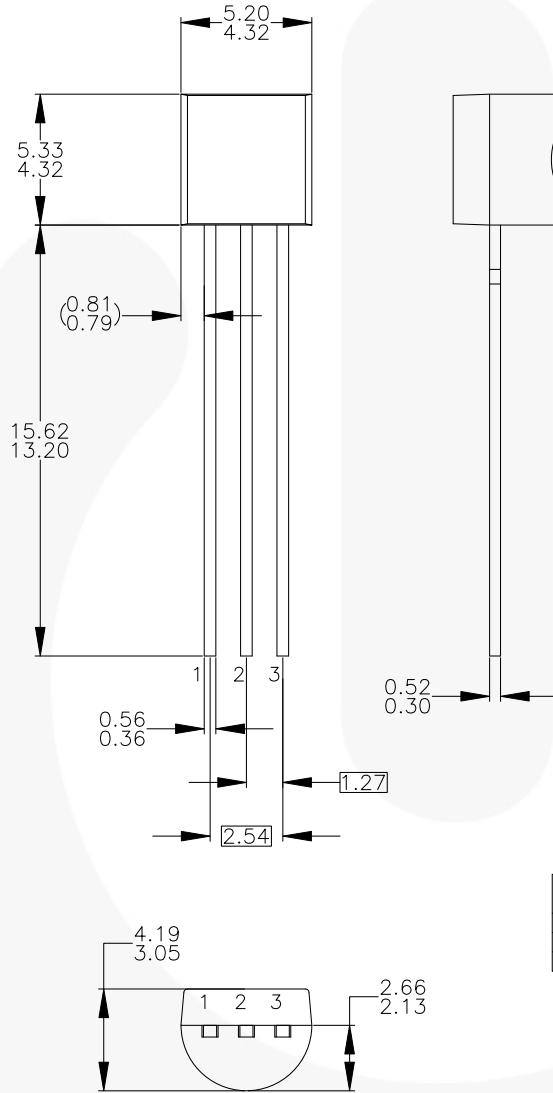


Figure 9. Power Dissipation vs. Ambient Temperature

Physical Dimensions

TO-92 (Bulk)



NOTES: UNLESS OTHERWISE SPECIFIED

- A) DRAWING WITH REFERENCE TO JEDEC TO-92 RECOMMENDATIONS.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-1994.
- D) TO-92 (92,94,96,97,98) PIN CONFIGURATION:

| PIN | 92 | | | 94 | | | 96 | | | 97 | | | 98 | | |
|-----|----|---|---|----|---|---|----|---|---|----|---|---|----|---|---|
| | P | F | M | P | F | M | B | F | M | P | F | M | P | F | M |
| 1 | E | S | S | E | S | S | B | D | G | C | G | D | C | G | D |
| 2 | B | D | G | C | G | D | E | S | S | B | D | G | E | S | S |
| 3 | C | G | D | B | D | G | C | G | D | E | S | S | B | D | G |

LEGEND:

- P - BIPOLAR
- F - JFET
- M - DMOS
- E - EMITTER
- B - BASE
- C - COLLECTOR
- D - DRAIN
- S - SOURCE
- G - GATE

- E) FOR PACKAGE 92, 94, 96, 97 AND 98: PIN CONFIGURATION DRAIN "D" AND SOURCE "S" ARE INTERCHANGEABLE AT JFET "F" OPTION.
- F) DRAWING FILENAME: MKT-ZA03DREV3.

Figure 10. 3-LEAD, TO92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION (OLD TO92AM3) (ACTIVE)

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Physical Dimensions (Continued)

TO-92 (Tape and Reel, Ammo)

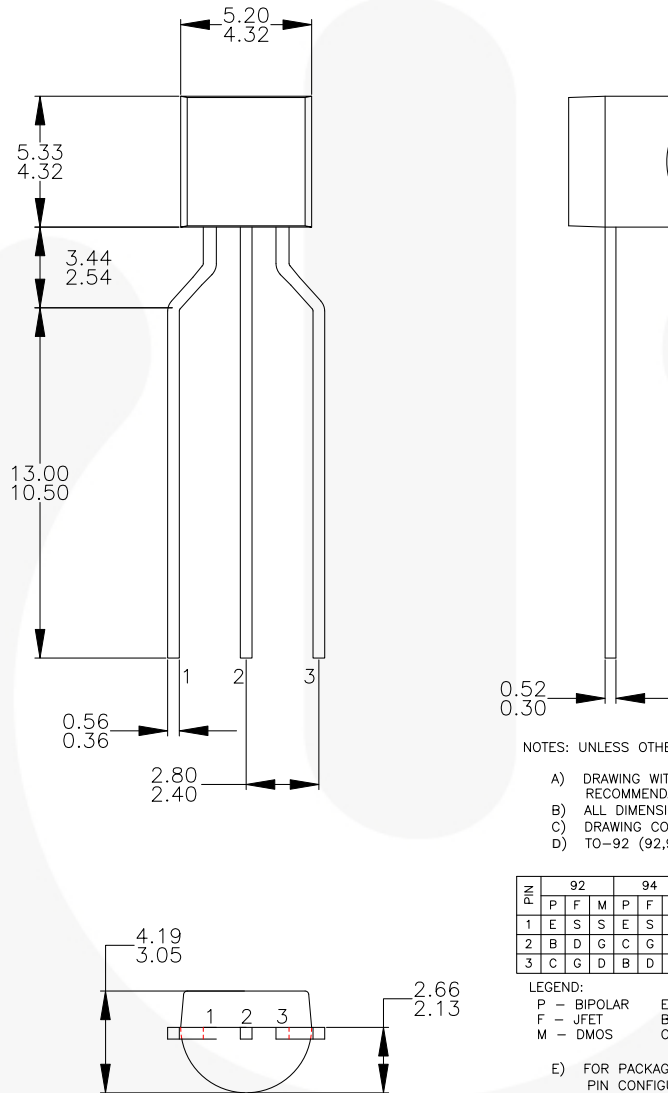


Figure 11. 3-LEAD, TO92, MOLDED, 0.200 IN-LINE SPACING LD FORM(J62Z OPTION) (ACTIVE)

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Physical Dimensions (Continued)

SOT-23

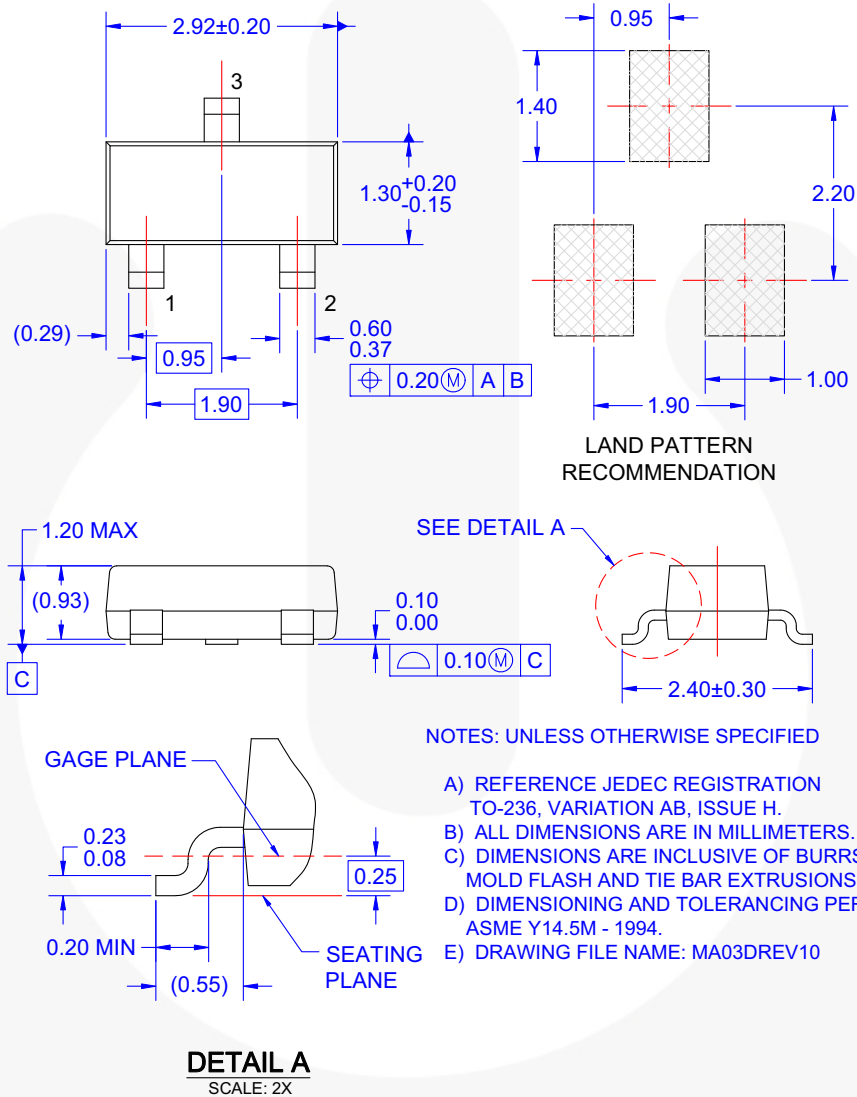


Figure 12. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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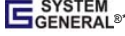



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